

BL STM32 MP157

Doc. Rev. 0.2



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▶ BL STM32 MP157 - USER GUIDE

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Revision History

Revision	Brief Description of Changes	Date of Issue	Author/Editor
Rev. 0.1	Initial version	2021-09-24	We
Rev. 0.2	Pre-Release	2022-05-11	We

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Symbols

The following symbols may be used in this user guide

ADANGER

DANGER indicates a hazardous situation which, if not avoided, will result in death or serious injury.

▲WARNING

WARNING indicates a hazardous situation which, if not avoided, could result in death or serious injury.

NOTICE

NOTICE indicates a property damage message.

ACAUTION

CAUTION indicates a hazardous situation which, if not avoided, may result in minor or moderate injury.



Electric Shock!

This symbol and title warn of hazards due to electrical shocks (> 60 V) when touching products or parts of products. Failure to observe the precautions indicated and/or prescribed by the law may endanger your life/health and/or result in damage to your material.



ESD Sensitive Device!

This symbol and title inform that the electronic boards and their components are sensitive to static electricity. Care must always therefore be taken during all handling operations and inspections of this product in order to ensure product integrity.



HOT Surface!

Do NOT touch! Allow to cool before servicing.



Laser!

This symbol informs of the risk of exposure to laser beam and light emitting devices (LEDs) from an electrical device. Eye protection per manufacturer notice shall review before servicing.



This symbol indicates general information about the product and the user guide.

This symbol also indicates detail information about the specific product configuration.



This symbol precedes helpful hints and tips for daily use.

For Your Safety

Your new Kontron Electronics product was developed and tested carefully to provide all features necessary to ensure its compliance with electrical safety requirements. It was also designed for a long fault-free life. However, the life expectancy of your product can be drastically reduced by improper treatment during unpacking and installation. Therefore, in the interest of your own safety and of the correct operation of your new Kontron Electronics product, you are requested to conform with the following guidelines.

High Voltage Safety Instructions

As a precaution and in case of danger, the power connector must be easily accessible. The power connector is the product's main disconnect device.



Warning

All operations on this product must be carried out by sufficiently skilled personnel only.

Electric Shock!

ACAUTION



Before installing a non-hot-swappable Kontron Electronics product into a system always ensure that the power is switched off. This also applies to the installation of piggybacks. Serious electrical shock hazards can exist during all installation, repair, and maintenance operations on this product. Therefore, always unplug the power cable and any other cables which provide external voltages before performing any work on this product.

Earth ground connection to vehicle's chassis or a central grounding point shall remain connected. The earth ground cable shall be the last cable to be disconnected or the first cable to be connected when performing installation or removal procedures on this product.

▲WARNING



Please read this chapter carefully and take careful note of the instructions that have been compiled for your safety and to ensure to apply in accordance with intended regulations. If the following general safety instructions are not observed, it could lead to injuries to the operator and/or damage of the product; in cases of non-observance of the instructions Kontron Electronics is exempt from accident liability, this also applies during the warranty period.

The product has been built and tested according to the basic safety requirements for low voltage (LVD) applications and has left the manufacturer in safety-related, flawless condition. To maintain this condition and to ensure safe operation, the operator must not only observe the correct operating conditions for the product but also the following general safety instructions:

- The product must be used as specified in the product documentation, in which the instructions for safety for the product and for the operator are described. These contain guidelines for setting up, installation and assembly, maintenance, transport and storage.
- The on-site electrical installation must meet the requirements of the country's specific local regulations.
- If a power cable comes with the product, only this cable should be used. Do not use an extension cable to connect the product.
- Do not place the system close to heat sources or damp places.
- Only products or parts which fulfil the requirements of SELV circuits (Safety Extra Low Voltage) as stipulated by IEC 60950-1 may be connected to the available interfaces.
- If the product is modified for the insertion or removal of expansion devices (depending on the configuration of the system), this may only be carried out by qualified persons.
- If extensions are made to the product, the following must be observed:
 - All effective legal regulations and all technical data for the expansion devices are adhered to.
 - The power consumption of any expansion devices does not exceed the specified limitations.
 - The current consumption of the system does not exceed the value stated on the product label.
- Only original accessories that have been approved by Kontron Electronics can be used.
- Please note: safe operation is no longer possible when any of the following applies:
 - Damage is visible.
 - The device no longer functions.

In these cases, the device must be switched off and it must be ensured that the device can no longer be operated.

Additional Safety Instructions for DC Power Supply Circuits

- To guarantee safe operation of products with DC power supply voltages larger than 60 volts DC or a power consumption larger than 240 VA, please observe that:
 - The product is set up, installed and operated in a room or enclosure marked with "RESTRICTED ACCESS", if there are no safety messages on product as safety signs and labels on the product itself.
 - No cables or parts without insulation in electrical circuits with dangerous voltage or power should be touched directly or indirectly.
 - A reliable protective earthing connection is provided.
 - A suitable, easily accessible disconnecting product is used in the application (e.g. overcurrent protective product), if the product itself is not disconnectable.
 - A disconnect product, if provided in or as part of the equipment, shall disconnect both poles simultaneously.
 - Interconnecting power circuits of different products causes no electrical hazards.
- A sufficient dimensioning of the power cable wires must be selected according to the maximum electrical specifications on the product label as stipulated by EN60950-1 or VDE0100 or EN60204 or UL508 regulations.
- The product does not generally fulfil the requirements for "centralized DC power systems" (UL 60950-1, Annex NAB; D2) and therefore may not be connected to such products!

Special Handling and Unpacking Instruction

NOTICE

ESD Sensitive Device!



Electronic boards and their components are sensitive to static electricity. Therefore, care must be taken during all handling operations and inspections of this product, in order to ensure product integrity at all times.

Do not handle this product out of its protective enclosure while it is not used for operational purposes unless it is otherwise protected.

Whenever possible, unpack or pack this product only at EOS/ESD safe workstations. Where a safe workstation is not guaranteed, it is important for the user to be electrically discharged before touching the product with his/her hands or tools. This is most easily done by touching a metal part of your system housing.

It is particularly important to observe standard anti-static precautions when changing piggybacks, ROM devices, SD cards, jumper settings etc. If the product contains batteries for RTC or memory backup, ensure that the product is not placed on conductive surfaces, including anti-static plastics or sponges. They can cause short circuits and damage the batteries or conductive circuits on the product.

Lithium Battery Precautions

If your product is equipped with a lithium battery, take the following precautions when replacing the battery.



Danger of explosion if the battery is replaced incorrectly.

- Replace only with same or equivalent battery type recommended by the manufacturer.
- Dispose of used batteries according to the manufacturer's instructions.

General Instructions on Usage

In order to maintain Kontron Electronics' product warranty, this product must not be altered or modified in any way. Changes or modifications to the product, that are not explicitly approved by Kontron Electronics and described in this user guide or received from Kontron Electronics Support as a special handling instruction, will void your warranty.

This product should only be installed in or connected to systems that fulfil all necessary technical and specific environmental requirements. This also applies to the operational temperature range of the specific board version that must not be exceeded. If batteries are present, their temperature restrictions must be considered.

In performing all necessary installation and application operations, only follow the instructions supplied by the present user guide.

Keep all the original packaging material for future storage or warranty shipments. If it is necessary to store or ship the product, then re-pack it in the same manner as it was delivered.

Special care is necessary when handling or unpacking the product. See Special Handling and Unpacking Instruction.

Quality and Environmental Management

Kontron Electronics aims to deliver reliable high-end products designed and built for quality, and aims to complying with environmental laws, regulations, and other environmentally oriented requirements. For more information regarding Kontron Electronics' quality and environmental responsibilities, visit

https://www.kontron-electronics.com/company/about-us/germany/

Disposal and Recycling

Kontron Electronics' products are manufactured to satisfy environmental protection requirements where possible. Many of the components used are capable of being recycled. Final disposal of this product after its service life must be accomplished in accordance with applicable country, state, or local laws or regulations.

WEEE Compliance

The Waste Electrical and Electronic Equipment (WEEE) Directive aims to:

- Reduce waste arising from electrical and electronic equipment (EEE).
- Make producers of EEE responsible for the environmental impact of their products, especially when the product become waste.
- Encourage separate collection and subsequent treatment, reuse, recovery, recycling and sound environmental disposal of EEE.
- Improve the environmental performance of all those involved during the lifecycle of EEE.



Environmental protection is a high priority with Kontron Electronics. Kontron Electronics follows the WEEE directive.

You are encouraged to return our products for proper disposal.

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1/ Introduction

This user guide describes the Board-Line BL STM32 MP157. New users are recommended to study the installation instructions within this user guide before switching on the power.

Kontron Electronics' BL STM32 MP157 is developed for different applications for use when space is limited. The fanless design ensures a significantly prolonged lifespan and high system availability.

1.1. Product Overview

Before working with the BL STM32 MP157, Kontron Electronics recommends that users take a few minutes to learn about the various parts of the BL STM32 MP157.

The BL STM32 MP157 is a flexible single board computer fanless device designed for use in demanding applications. Based on the STM32 MP157 (2x Arm® Cortex®-A7, 1x Arm® Cortex®-M4) processor the BL STM32 MP157 features long-term availability and supports a varied number of onboard interfaces to enable connectivity to nearly all applications. A microSD card slot supports memory expansion for flexible data storage.

All variants are also available as a separate product named Automation-Line AL STM32 MP157 in a robust steel chassis, designed for operation in a DIN rail environment using a vertical orientation.

Please contact us for detailed information or visit: http://www.kontron-electronics.com

General features are:

- STM32 MP157AAD 2x Arm® Cortex®-A7 processor, 1x Arm® Cortex®-M4 Processor
- > 512 MB DDR3-RAM with 512 MB NAND-Flash and 2 MB NOR-Flash
- 4 GB Memory Storage via soldered eMMC
- External microSD Card Slot
- External Interfaces: 2x 10/100 Mbit/s Ethernet, 2x USB 2.0, 1x RS232, 1x RS485, 1x CAN, 2x DIO and 2x AIN, 1x LVDS, 1x RGB, 1x JTAG, (1x HDMI on demand)
- Fanless passive cooling (heatsink required)

The BL STM32 MP157 is intended for 24/7 continuous operation and longtime industrial applications. All components are selected to ensure a long lifetime.

Figure 1: BL STM32 MP157





The BL STM32 MP157 is designed for operation in a customer-specific enclosure or device. Please do not operate the BL STM32 MP157 without sufficient cooling system.

1.2. Ordering Information

Check that your delivery is complete, and contains the items listed below. If you discover damaged or missing items, contact your dealer.

Table 1: Scope of Delivery

ArtNo.	Delivered Item	Description
40099 176	BL STM32 MP157 512MB/512MB	Corresponding to the ordered product configuration
	Other systems on request	

1.3. Accessories

Table 2: Accessories

ArtNo.	Delivered Item	Description
10600 338	MicroSD Card	MicroSD Card 16 GB
30099 001	Power Supply	External power supply 230 V AC to 24 V DC / 18 W incl. 2-pin power connector (Phoenix Contact origin no. 1826680)
30099 003	Connector Set 24VDC/RS232/RS485/CAN/DIO	Connector set contains: 1x 2-pin power connector
Content will be changed soon!	mating connector	(Phoenix Contact origin no. 1826680) 1x RS232: 8-pin; 1x RS485/CAN: 8-pin; 1x DIO/AIN: 8-pin (Phoenix Contact origin no. 1844594)
40099 101	USB-UART Debug-Adapter	Translates the UART signals provided on the Mini-B USB connector to USB for connecting the BL STM32 MP157 to a computer

2/ Specification

2.1. Technical Specification

The BL STM32 MP157 implements the following mainboard technical specification.

Table 3: Technical Specification

Processor	2x Arm® Cortex®-A7 @650 MHz,
110003301	l control de la control de
	1x Arm® Cortex®-M4 @200 MHz, 3D GPU
System Memory	512 MB DDR3-RAM
Storage	4 GB eMMC, 512 MB NAND-Flash and 2 MB NOR-Flash
Interfaces	2x USB 2.0, USB A
	1x USB OTG, Micro-USB
	1x Debug, Mini-B USB
	2x 10/100 Mbit/s Ethernet
	1x RS232
	1x RS485
	1x CAN
	2x DIO (24 V DC/up to 800 mA)
	2x AIN (024 V)
	1x LVDS
	1x JTAG
	(1x HDMI)
Expansion Sockets	1x microSD Slot
	1x RGB
Power	24 V DC ±20 % Input

Table 4: Software Specification

Operating System (OS)	Yocto Linux		1
	BSP documentation and support:	https://docs.kontron-electronics.de	

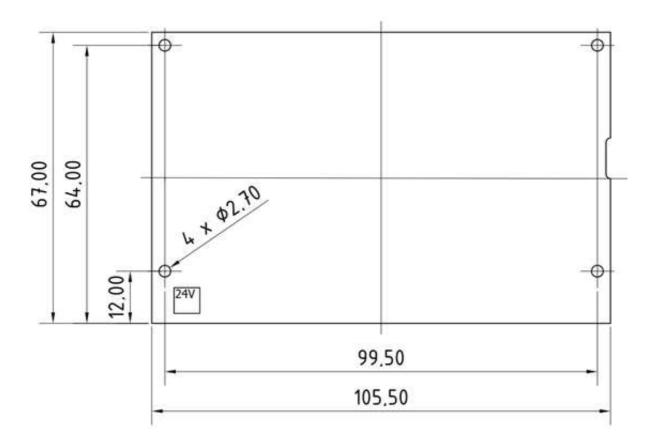
2.2. Mechanical Specification

Table 5: Mechanical Specification

Dimensions	BL STM32 MP157		
Width	105,5 mm (4,15")		
Depth	67 mm (2,64")		
Height	24 mm (0,94")	Not yet verified by measurement!	
Weight	Approx. ~0,07 kg (~0,15 lbs.)		
Mounting	Screw Mounting (M2.5)		

For more detailed mechanical information, refer to the following outline dimensions drawing within this chapter. It shows the main external mechanical features such as the position and size of mounting holes.

Figure 2: Dimensions (Measurements in Millimetres)



2.3. Power Specification

The BL STM32 MP157 is powered by a 2-pin Input power connector on the front and has no internal power supply. The standard input voltage of 24 V DC is converted internally to supply all other required voltages.

NOTICE

Hot Plugging the power supply is not supported. Hot plugging might damage the board.

Table 6: Power Specification

Nominal Input Voltage	24 V DC		
Nominal Power Consumption	2.5 W		
Input Voltage Range	24 V DC ±20 %		
Input Power	max. 8 A (connector current)		
Output Current 3.3 V	1 A	Not yet verified by measurement!	
Output Current 5 V	2 A		
Output Current DOUT	1.6 A		
Input Power Mating Connector	nput Power Mating Connector 2-pin Phoenix Contact 180° FMC 1,5/2-ST-3,5 (Phoenix 1826680)		

NOTICE

The maximum output current of all outputs together is divided between the 5 V and 3 V paths. The maximum output currents for 5 V and 3 V given in the table above each refer to the use of this voltage only and are reduced accordingly when using both voltages.

2.3.1. Power Consumption

The power consumption of the BL STM32 MP157 depends on the implemented mainboard capacity and external interfaces, for more information see Table 7: Power Consumption.

Figure 3: Power Tree

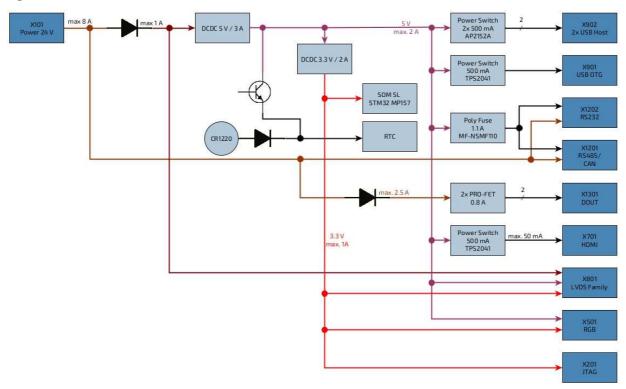


Table 7: Power Consumption

Power Figures SBC	BL STM32 MP157	
MP157 run	6401200 mW	
1x LVDS	Backlight: 3.3 V * 1000 mA = 3.3 W or 5.0 V * 2000 mA = 10 W or 24 V * 300 mA = 7.2 W	
1x HDMI	5 V * 50 mA = 250 mW	Not yet verified by measurement!
LAN 1	150 mW	
LAN 2	350 mW	
2x USB 2.0	2x 5 V * 500 mA = 5 W	
1x USB OTG	5 V * 500 mA = 2.5 W	
DOUT	2x 800 mA * 24 V = 38.4 W	

MP157 power numbers are typical values based on typical silicon at 25 °C. Power numbers distributed to external devices are max. allowed values, partially overcurrent protected.



Please refer to STM32 MP1 Series system power consumption document for further details.

2.3.2. Functional Earthing System

A functional earth connection to the board will be possible via the four mounting holes. These contact surfaces are directly attached to the electronic ground and the GND pin of the power connector.

2.3.3. Environmental Specification

Table 8: Environmental Specification

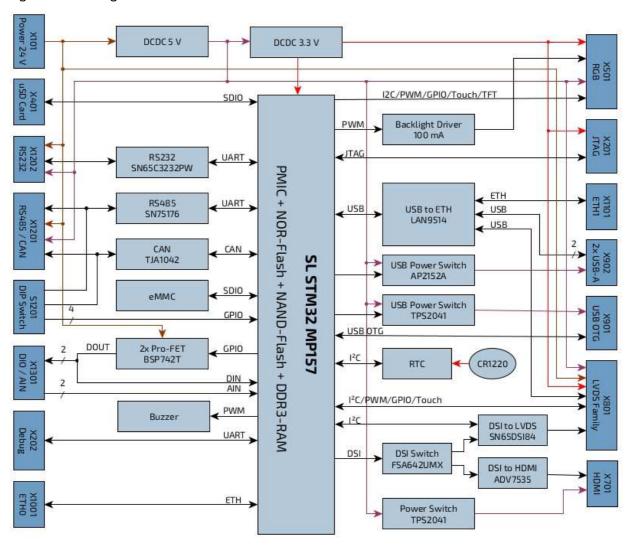
Temperature (Operating) 055 °C ambient		Not yet verified by measurement!	
Relative Humidity (Operating)	93 % @ 40 °C, non-condensing	,	



The BL STM32 MP157 is designed for operation in a customer-specific enclosure or device. Please do not operate the STM32 MP157 without sufficient cooling system.

2.4. Block Diagram

Figure 4: Block Diagram



3/ Connector Description

All I/O connectors are located on the top side of the board.

Figure 5: Top Side View

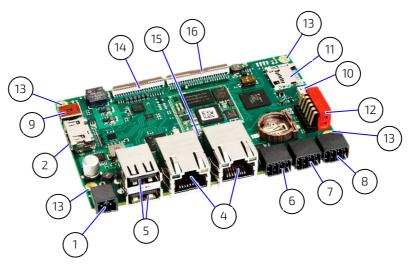


Table 9: Overview of all Connectors

Item	Label	Function	See Chapter
1	X101	DC Power Connector (2-pin Phoenix Contact)	3.2.1
2	X701	HDMI Connector	3.2.2
4	X1101 / X1001	10/100 Mbit/s LAN 2 / 1 RJ-45 Connector	3.2.3
5	X902	USB2.0 Port 0 / 1 Connector (upper / lower)	3.2.4
6	X1202	RS232 Connector	3.2.5
7	X1201	RS485 / CAN Connector	3.2.6
8	X1301	DIO/AIN Connector	3.2.7
9	X202	Debug UART Connector	3.2.8
10	X901	USB OTG Connector	3.2.9
11	X401	MicroSD Card Slot	3.2.10
12	51201	Switch CAN Address	3.2.6
13	FE	Functional Earth Connection	3.1.13
14	X801	LVDS Connector	3.2.11
15	X201	JTAG Connector	3.2.12
16	X501	RGB Family Connector	3.2.13

3.1.1. Power Connector

There is one 2-pin power connector supporting an input DC voltage of 24 V DC ±20 %, see Figure 5 (pos. 1). The mating connector required to connect the power connector to a DC main power source is delivered with the BL STM32 MP157. For information on how to connect the supplied mating connector to the input power connector, refer to Chapter 6.2.1: Wiring the DC Mating Power Connector.

For the pin assignment of the input power connector, refer to Chapter 3.2.1: Power Connector.

3.1.2. HDMI Interface

There is one HDMI interface (1024 x 600 pixel resolution), for video solutions, see Figure 5 (pos. 2). Function is limited to certain displays. No standard HDMI timings available. The HDMI interface is not designed for connecting cables longer than 3 m. Use is recommended only after consultation.

For the pin assignment of the HDMI connector, refer to Chapter 3.2.2: HDMI Connector (X701).

3.1.3. Ethernet (LAN2, LAN1) Interface

There are two LAN ports, see Figure 5 (pos. 4). In the software these are referred to as ETHO and ETH1. The assignment between LAN2/LAN1 and ETH0/ETH1 depends on the software.

In order to achieve the specified performance of the Ethernet port, shielded category 5 twisted pair cables must be used with 10/100 Mbit/s LAN networks.

For the pin assignment of the RJ45 Ethernet connectors, refer to Chapter 3.2.3: Ethernet RJ45 Connectors (X1101 / X1001).

3.1.4. USB 2.0 Interface

There are two USB 2.0 ports allowing for the connection of USB 2.0 compatible devices, see Figure 5 (pos. 5). The USB ports are designed for connecting short cables only.

For the pin assignment of the USB 2.0 connectors, refer to Chapter 3.2.4: USB Connectors (X902).

3.1.5. RS232 Interface

There is a RS232 interface (RX/TX) supporting RTS/CTS, see Figure 5 (pos. 6). The RS232 interface is not designed for connecting cables longer than 3 m.

For the pin assignment of the RS232 connector, refer to Chapter 3.2.5: RS232 Connector (X1202).

3.1.6. RS485 Interface

The RS485 interface (see Figure 5 pos. 7) also contains the wiring for CAN. The RS485 interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the RS485 / CAN connector, refer to Chapter 3.2.6: RS485/CAN Connector (X1201).

3.1.7. CAN Interface

The connector for CAN (see Figure 5 (pos. 7) also contains the wiring for RS485. The CAN address switches 1...4 are connected directly to GPIO pins and can therefore also be used for other purposes. The CAN interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the RS485 / CAN connector, refer to Chapter 3.2.6: RS485/CAN Connector (X1201).

3.1.8. DIO Interface

There is a two port DIO interface available on the front panel of the BL STM32 MP157, see Figure 5 (pos. 8).

The DIO pins consist of a 24 V high side switch, capable of driving 800 mA. The voltage level is according to the supply voltage. When the output is disabled, the pin can be used as 24 V input.

The DIO interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the DIO/AIN connector, refer to Chapter 3.2.7: DIO/AIN Connector (X1301).

3.1.9. AIN Interface

There is a two port AIN interface available on the front panel of the BL STM32 MP157, see Figure 5 (pos. 8).

The AIN pins can be used for a voltage between 0 V and the supply voltage. The AIN interface is not designed for connecting cables longer than 30 m.

For the pin assignment of the DIO/AIN connector, refer to Chapter 3.2.7: DIO/AIN Connector (X1301).

3.1.10. Debug Interface

There is a Debug interface using UART protocol with a Mini-B USB connector, see Figure 5 (pos. 9).

An additional adapter is needed to translate the 3.3 V UART signals (provided on the Mini-B USB connector) to USB. The Debug interface is for service purpose and should only be used by qualified personnel.

For the pin assignment of the debug connector, refer to Chapter 3.2.8: USB Debug Connector (X202).

3.1.11. USB OTG Interface

There is a Micro-USB OTG connector that can be used as USB 2.0 compatible device or host, see Figure 5 (pos. 10).

The USB OTG interface is for service purpose and should only be used by qualified personnel.

For the pin assignment of the USB OTG connector, refer to Chapter 3.2.9: USB OTG Connector (X901).

3.1.12. MicroSD Card Slot

There is a card slot to connect a microSD card for extra memory, see Figure 5 (pos. 11).

For the pin assignment of the microSD card slot, refer to Chapter 3.2.10: MicroSD Card.

3.1.13. Functional Earth Connection

The GND pin of the power connector is connected to functional earth of the electronics and to the four mounting holes on the edges of the circuit board.

3.1.14. LVDS Interface

There is a LVDS interface to connect a LVDS display, see Figure 5 (pos. 14).

For the pin assignment of the LVDS connector, refer to Chapter 3.2.11: LVDS Family Connector (X801).

3.1.15. JTAG Interface

There is a JTAG interface for programming and debugging, see Figure 5 (pos. 15).

For the pin assignment of the JTAG connector, refer to Chapter 3.2.12: JTAG Connector (X201).

3.1.16. RGB Interface

There is a RGB interface to connect a RGB display, see Figure 5 (pos. 16).

For the pin assignment of the RGB connector, refer to Chapter 3.2.13: RGB Family Connector (X501).

3.2. Connector Pin Assignments

3.2.1. Power Connector (X101)

2-Pin Power Mating Connector	Pin	Signal Name
表表	1	VCC
	2	GND
1 2		

Phoenix Contact Connector 180° FMC 1,5/2-ST-3,5 (Phoenix 1826680)

3.2.2. HDMI Connector (X701)

HDMI	Pin	Signal Name
	1	TMDS Data2+
	2	GND
	3	TMDS Data2-
	4	TMDS Data1+
	5	GND
	6	TMDS Data1-
	7	TMDS Data0+
	8	GND
	9	TMDS Data0-
	10	TMDS Clock+
		GND
	12	TMDS Clock-
	13	Reserved
	14	Reserved
	15	DDC_CLK
	16	DDC_DATA
	17	GND
	18	+5 V Power
	19	Hot Plug Detect

3.2.3. Ethernet RJ45 Connectors (X1101 / X1001)

2x RJ45 (female)	Pin	Signal Name	Pin	Signal Name
	1	TX+	5	n.c.
	2	TX-	6	RX-
	3	RX+	7	n.c.
	4	n.c.	8	n.c.

Left LED: Activity / Link		Right LED: Activity 10/100		
Off 10 Mbit/s		Off	No LAN connectivity	
Green	100 Mbit/s	Yellow	Link	
		Blinking	Activity	

3.2.4. USB Connectors (X902)

2x USB A 2.0	Pin	Signal Name
	1	+USB_VCC
	2	D-
	3	D+
	4	GND

3.2.5. RS232 Connector (X1202)

RS232 Interface	Pin	RS232
CACA CA	1	VIN
2 4 6 8 1 88 1 88 1 88 1 88 1 88 1 88 1 8	2	GND
	3	TxD
	4	RxD
1	5	RTS
	6	CTS
	7	+5 V DC
Comme	8	GND

Phoenix Contact Connector 180° DFMC 0,5/4-ST-2,54 (Phoenix 1844594)

3.2.6. RS485/CAN Connector (X1201)

RS485/CAN Interface	Pin	Signal Name
CARACA CA	1	VIN
	2	GND
	3	RS485 A
	4	CAN H
1	5	RS485 B
	6	CAN L
A STATE	7	+5 V DC
Military	8	GND

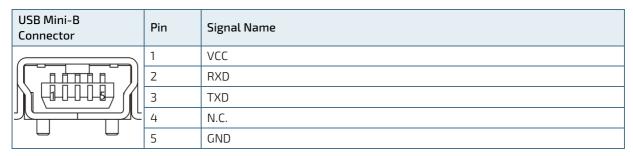
Phoenix Contact Connector 180° DFMC 0,5/4-ST-2,54 (Phoenix 1844594)

CAN Address	Switch	Signal Name
	1	Address 1
1ON	2	Address 2
3	3	Address 3
5	4	Address 4
	5	CAN Termination (121 Ω)
	6	RS485 Termination (121 Ω)

3.2.7. DIO/AIN Connector (X1301)

DIO / AIN Interface	Pin	Signal Name
Charles Charles	1	DOUT1 / DIN1 (DOUT Imax = 800 mA)
88 88 88 88 88 88 88 88 88 88 88 88 88	2	GND
	3	DOUT2 / DIN2 (DOUT Imax = 800 mA)
	4	GND
No.	5	AIN1 (024 V)
	6	GND
2230	7	AIN2 (024 V)
- IIII	8	GND

3.2.8. USB Debug Connector (X202)



You need an additional adapter to translate the UART signals provided on the Mini-B USB connector to USB. This adapter must be connected between an USB port on your computer and the debug interface on the BL STM32 MP157 board using a standard USB cable.

Figure 6: USB-UART Debug-Adapter



This adapter is only supplied as standard with our development kits but can also be ordered separately.

For more detailed information please have a look at the online documentation https://docs.kontron-electronics.de.

This documentation includes all information you need to put your device into operation including a quick start guide as well as further information on how to get access to the Yocto based GitLab software repository and how to make your own software images.

3.2.9. USB OTG Connector (X901)

Micro-USB Connector	Pin	Signal Name
	1	+USB_VCC
	2	D-
The state of the s	3	D+
	4	ID
	5	GND

3.2.10. MicroSD Card Slot (X401)

MicroSD Card	Pin	Signal Name
	1	DTA2
	2	CD/DAT3
	3	CMD
	4	VDD
	5	CLK
	6	VSS
	7	DAT0
	8	DAT1



Pay attention to the manufacturer's lifespan specification. Due to the limited lifespan of SD cards/SSD drives Kontron Electronics recommends checking the condition regularly.

3.2.11. LVDS Family Connector (X801)

ZIF 40pol.	Pin	Signal Name	Pin	Signal Name
	1	VCC 3.3 V	21	RXIN3+
	2	VCC 3.3 V	22	GND
	3	VCC 3.3 V	23	USB_DN
	4	GPI00	24	USB_DP
	5	GPI01	25	GND
	6	STBY	26	I2C2_SDA
	7	GND	27	I2C2_SCL
	8	RXINO-	28	TOUCH_INT
	9	RXIN0+	29	TOUCH_RST
	10	GND	30	GND
	11	RXIN1-	31	+24 V
	12	RXIN1+	32	+24 V
	13	GND	33	GPI02
	14	RXIN2-	34	GPIO3
	15	RXIN2+	35	PWM1
	16	GND	36	GND
	17	RXCLKIN-	37	GND
	18	RXCLKIN+	38	+5 V
	19	GND	39	+5 V
	20	RXIN3-	40	+5 V

Connector Type

X6: Molex ZIF-Buchse 501951-4010 (180° FPC 40 pol. RM0,5)

3.2.12. JTAG Connector (X201)

2x5pol. RM1,27 Male	Pin	Signal Name	Pin	Signal Name
	1	VCC 3.3 V	6	JTAG_TDO
2	2	JTAG_TMS	7	JTAG_TRST
100000	3	GND	8	JTAG_TDI
'	4	JTAG_TCK	9	GND
	5	GND	10	RESET_IN

3.2.13. RGB Family Connector (X501)

ZIF Molex-FPC 50-pol 501951	Pin	Signal Name	Pin	Signal Name
	1	VLED-	26	B3
	2	VLED+	27	B4
	3	GND	28	B5
	4	+3.3 V VDD	29	B6
	5	R0	30	B7
	6	R1	31	GND
	7	R2	32	DCLK
	8	R3	33	DISP
	9	R4	34	HSYNC
	10	R5	35	VSYNC
	11	R6	36	DE
	12	R7	37	GND
	13	GND	38	+5 V
	14	GO	39	+5 V
	15	G1	40	GND
1 = 3	16	G2	41	GND
	17	G3	42	GPI00
	18	G4	43	GPI01
	19	G5	44	GND
	20	G6	45	GND
	21	G7	46	+3.3 V Touch
	22	GND	47	SDA Touch
	23	В0	48	SCL Touch
	24	B1	49	Wake Touch
	25	B2	50	INT Touch

Connector Type

X501: Molex ZIF-Buchse 501951-5010 (180° FPC 50 pol. RM0,5)

4/ Accessing Components

This chapter contains important information that users must read before accessing components. Follow these procedures properly when accessing or installing component to extend the system.



The installation/removal of system components may only be performed by a qualified person. Observe the "General Safety Instructions for IT-Equipment" and the "installation instructions" contained within this user guide.



ESD Sensitive

Follow the safety instructions for components that are sensitive to electrostatic discharge (ESD). Failure to observe this warning notice may result in damage to the product or/and internal components.



Because of the limited predetermined lifespan of expansion devices, Kontron Electronics recommends checking the condition of installed expansion devices regularly and to pay attention to the manufacturer specifications for lifespan.

4.1. Accessing External Components

4.1.1. MicroSD Card Slot

The BL STM32 MP157 supports a removable microSD card.

To remove/install a removable microSD card, perform the following steps:

- Press the microSD card on the right-hand side of the BL STM32 MP157, to remove a microSD card out of the slot.
- 2. The microSD card automatically slides out a bit for removal.
- 3. Slide in the microSD card, if needed. Take care of the correct position.

5/ Thermal Considerations

Hot Surface

Danger of burns. Board can get very hot. To avoid burns and personal Injury:



- Do not touch the board when the product is in operation
- Allow the product to cool before handling
- Wear protective gloves
- Always turn the product off when not in use

The BL STM32 MP157 is a fanless and passively cooled system. When mounting the BL STM32 MP157 in a DIN rail enclosure or housing take care not to obstruct the airflow over the chassis, as this stops sufficient heat dispersing into the ambient environment and causes a build-up of heat.



The STM32 MP157 is designed for operation in a customer-specific enclosure or device. Please do not operate the STM32 MP157 without sufficient cooling system.

6/ Installation Instructions

6.1. Requirements IEC60950-1

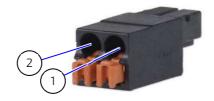
Take care when designing chassis interface connectors in order to fulfil the IEC60950-1 standard. Users of STM32 MP157 must evaluate the end product to ensure compliance the requirements of the IEC60950-1 safety standard are met:

- The motherboard must be installed in a suitable mechanical, electrical and fire enclosure.
- The system in its enclosure must be evaluated for temperature and air flow considerations.
- The motherboard must be powered by a CSA or UL approved power supply that limits the maximum input current to 8 A to the 24 V 2-pin DC power connector.
- For interfaces having a power pin such as external power or fan, ensure that the connectors and wires are suitably rated. All connections from/to the product shall be with SELV circuits only.
- Wires have suitable rating to withstand the maximum available power.
- The enclosure of the peripheral device fulfils the fire protecting requirements of IEC60950-1.

6.2. Power Connector

The BL STM32 MP157 is connected by the input power connector to a DC power source via a DC power supply wiring consisting of the power mating connector and the assembled wires. For information on how to wire the connector, see Chapter 6.2.1: Wiring the DC Mating Power Connector.

Figure 7: Phoenix Power Mating Connector



- 1 Location for inserting the 24 V wire
- 2 Location for inserting the 0 V wire

6.2.1. Wiring the DC Mating Power Connector

To wire the power mating connector, follow the steps below.

- 1. Cut two (0.5...1.5 mm²) AWG 20...16 isolated wires to the required length and strip each end 5...7 mm.
- 2. Twist the striped wire-ends and provide them with ferrules.
- 3. Press the contact levers of the power mating connector down far enough so that you can insert the end of the prepared wires.
- 4. Insert the wires into the corresponding clamp of the Phoenix power mating connector. Make sure that you have the right polarity of the connection. For the pin assignment of the input power connector, refer to Chapter 3.2.1: Power Connector.



The wires used for power connections must be clearly marked (+/-) to ensure proper connection to the front panel input power connector and to the main power source. In addition, the cables must have some form of support to minimize the strain on the unit's connectors.

ESD Sensitive Device!

 ${\bf Electrostatic\ discharge\ (ESD)\ can\ damage\ equipment\ and\ impair\ electrical\ circuitry.}$

- o Wear ESD-protective clothing and shoes.
- o Wear an ESD-preventive wrist strap attached to a good earth ground.
- o Check the resistance value of the wrist strap periodically (OK: 1 M Ω to 10 M Ω).
- o Transport and store the board in its antistatic bag.
- o Handle the board at an approved ESD workstation.
- o Handle the board only by the edges.



7/ Starting Up

Before using the system, become familiar with the system components and follow the startup instructions below.

7.1. Connecting to Power Supply

The BL STM32 MP157 connects to a DC main power supply via a Phoenix Contact input power connector on the front panel and corresponding power cable.



When starting the BL STM32 MP157, the functional earth connection must always be made first and disconnected last. Kontron Electronics recommended that the last connections attached to the system should be the power cable. Following a proper cabling procedure will prevent a false power-on condition, which could result in an operational failure.



The BL STM32 MP157 must be connected to a DC mains power supply complying with the SELV (Safety Extra Low Voltage) requirements of EN 60950-1 standard. It must be observed that wiring and short-circuit/overcurrent protection is performed according to the applicable standards, regulations and respect to the electrical specification of the BL STM32 MP157. The disconnecting device (fuse/circuit breaker) rating must be in accordance with the BL STM32 MP157's wire cross-section.

To start the BL STM32 MP157, follow the steps below:

- 1. Ensure that the DC power source is switched off via a disconnecting device (circuit breaker), in order to ensure that no power is flowing from the external DC power source during the connection procedure.
- 2. Connect the power connector with wiring (refer to Chapter 6.1: Requirements IEC60950-1) to the Input power connector, see Figure 5 (pos. 1).
- **3.** Pay attention to the polarity of the connections. For more information on the input power connector's polarity, see Chapter 3.2.1: Power Connector.
- 4. Connect the DC power cable's other end to the DC main power supply.
- 5. Switch on the disconnecting device (circuit breaker) in order to apply voltage to the BL STM32 MP157.



Do not disconnect the power from BL STM32 MP157 while BL STM32 MP157 is powered up! Performing a forced shutdown can lead to loss of data or other undesirable effects!

7.2. Operating System (OS) and Drivers

The standard BL STM32 MP157 is fully operational when switched on for the first time with pre-installed OS and drivers. Drivers are available from Kontron Electronics' GitLab Server https://git.kontron-electronics.de.

If ordered without pre-installed OS, before starting the BL STM32 MP157 the operating system and the appropriate drivers need to be installed for the ordered system configuration.

8/ Standards, Certifications and Directives

The BL STM32 MP157 is currently in test and aims to comply with the requirements of the following standards.



If the user modifies the product, prerequisites for specific approvals such as CE conformity declaration (safety requirements) may no longer apply.

Table 10: Standards, Certifications and Directives Compliance

Electromagnetic Compatibility	Directive 2014/30/EU
Low Voltage	Directive 2014/35/EU
RoHS II	Directive 2011/65/EU
EN 61000-6-2 EN 61000-6-3	Electromagnetic compatibility (EMC), part 6-2: Generic standards- Immunity for industrial environment
	Electromagnetic compatibility (EMC), part 6-3: Generic standards- Emission for industrial environment
Waste Electrical and Electronic Equipment Directive (WEEE Directive)	Compliant with the Waste Electrical and Electronic Equipment (WEEE) directive to reduce waste of electrical and electronic equipment, encourage recycling and environmental disposal and increase the environmental awareness of producers.
	Low Voltage RoHS II EN 61000-6-2 EN 61000-6-3 Waste Electrical and Electronic Equipment

9/ Shipment and Unpacking

9.1. Packaging

All parts are delivered together in a product specific cardboard package designed to provide adequate protection and absorb shock. Kontron Electronics recommends keeping the packaging to store or transport the product.

9.2. Unpacking

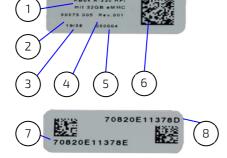
Proceed as follows to unpack the unit:

- 1. Remove packaging.
- 2. Do not discard the original packaging. Keep packaging for future relocation or storage.
- 3. Check the delivery for completeness by comparing it with the original order.
- 4. Keep the associated paperwork. It contains important information for handling the unit.
- 5. Check the contents for visible shipping damage.
- **6.** If you notice any shipping damage or inconsistencies between the contents and the original order, contact Kontron Electronics for help and information.

9.3. Type Label and Product Identification

The type label is position on contains the following information.

Figure 8: BL STM32 MP157 Type Label (Example)



- 1. Product name (BL STM32 MP157)
- **2.** Article number
- 3. Production date
- 4. Revision number
- **5.** Serial number
- **6.** Barcode with article-, rev., date and serial number
- **7.** MAC address
- 8. MAC address

10/Technical Support

10.1. First Steps - Startup-Information Baseboard

For the first startup of your Board, which includes the SoM SL STM32 MP157, you will find more information about the Software / BSP and additional hardware information at the online documentation.

Please follow the link: https://docs.kontron-electronics.de/yocto-ktn/build-ktn-imx/

The online documentation is primarily intended for our Eval-Kit / Evalboard but will help you also to put your BL STM32 MP157 into operation. Additionally, you will find information how to get access to the Yocto based GitLab software repository and how to make your own software images.

10.2. Extended Support

For detailed technical support please contact:

► E-mail: <u>support@kontron-electronics.de</u>

Make sure you have the following product identification information in your e-mail:

- Product name
- Product model number
- Serial number (SN) of the unit

Please explain the nature of your problem in your e-mail.



The serial number can be found on the type label on the system.

10.3. Disclaimer & License Information

The software contained in the device (BSP) contains parts which were licensed as free respectively open-source software under the GNU General Public License, version 2 and/or 3, respectively the GNU Lesser General Public License, versions 2.1 and/or 3.0.

You can obtain a pre-configured image at https://docs.kontron-electronics.de/ or contact:

Kontron Electronics GmbH Max-Planck-Str. 6 72636 Frickenhausen Germany

Web: http://www.kontron-electronics.com/ E-Mail: support@kontron-electronics.com/

11/Storage, Transportation and Maintenance

11.1. Storage

If the product is not in use for an extended period time, disconnect the power plug from the AC outlet. If it is necessary to store the product then re-pack the product as originally delivered to avoid damage. The storage facility must meet the products environmental requirements as stated within this user guide. Kontron Electronics recommends keeping the original packaging material for future storage or warranty shipments.

11.2. Transportation

To ship the product, use the original packaging, designed to withstand impact and adequately protect the product. When packing or unpacking products always take shock and ESD protection into consideration and use an EOS/ESD safe working area.

11.3. Maintenance

Maintenance or repair on the open product may only be carried out by qualified personnel authorized by Kontron Electronics.

Cleaning

- For light soiling, clean the product with a dry cloth.
- Carefully remove dust from the surface of the chassis and cooling fins using a clean, soft brush.
- Stubborn dirt should be removed using a mild detergent and a soft cloth.



Do not use steel wool, metallic threads or solvents like abrasives, alcohol, acetone or benzene for cleaning the BL STM32 MP157.

11.3.1. Replacing the Lithium Battery

The lithium battery must only be replaced with the same type of battery or with a type of battery recommended by Kontron Electronics. If the on-board Lithium battery needs to be replaced, follow the steps below:

- 1. Remove the lithium battery from the holder by pulling it outwards.
- 2. Place a new lithium battery in the battery holder.
- 3. Pay attention to the polarity of the battery.



Danger of explosion when replacing with wrong type of battery. Replace only with the same or equivalent type recommended by the manufacturer. The lithium battery type must be UL recognized.



Do not dispose of lithium batteries in general trash collection. Dispose of the battery according to the local regulations dealing with the disposal of these special materials, (e.g. to the collecting points for dispose of batteries).

12/Warranty

Kontron Electronics defines product warranty in accordance with regional warranty definitions. Claims are at Kontron Electronics' discretion and limited to the defect being of a material nature. To find out more about the warranty conditions and the defined warranty period for your region, following the steps below:

- 1. Visit Kontron Electronics' Term and Conditions webpage.
 - http://www.kontron-electronics.de/downloads
- 2. Click on the relevant document.

12.1. Limitation/Exemption from Warranty Obligation

In general, Kontron Electronics shall not be required to honor the warranty, even during the warranty period, and shall be exempted from the statutory accident liability obligations in the event of damage caused to the product due to failure to observe the following:

- General safety instructions for IT equipment within this user guide.
- Warning labels on the product and warning symbols within this user guide.
- Information and hints within this user guide.

Additionally, alterations or modifications to the product that are not explicitly approved by Kontron Electronics, described in this user guide, or received from Kontron Electronics Support as a special handling instruction will void your warranty.

Within the warranty period, the product should only be opened by Kontron Electronics. Removing the protection label and opening the product within the warranty period exempts the product from the statutory warranty obligation.

Due to their limited service life, parts which by their nature are subject to a particularly high degree of wear (wearing parts) are excluded from the warranty beyond that provided by law.

13/Disposal

Final disposal of this product after the product's service life must be accomplished in accordance with the applicable country, state, or local laws or regulations.



Kontron Electronics manufactures products to satisfy environmental protection requirements where possible. Many of the components used are capable of being recycled.

Kontron Electronics follows the Waste Electrical and Electronic Equipment (WEEE) Directive that aims to reduce waste arising from Electrical and Electronic waste and encourages customers to return Kontron Electronics products for proper disposal. For more information regarding WEEE compliance, see the Disposal and Recycling section at the start of this user guide.

Appendix

List of Acronyms

Table 11: List of Acronyms

BL Board Line (Board without housing) BSP Board Support Package (Software) CAN Controller Area Network (BUS) CPI Advanced Configuration Control Interface CPU Central Processing Unit CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things		
AL Automation Line (Board with housing) BL Board Line (Board without housing) BSP Board Support Package (Software) CAN Controller Area Network (BUS) CPI Advanced Configuration Control Interface CPU Central Processing Unit CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	AC	Alternating Current
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BSP Board Support Package (Software) CAN Controller Area Network (BUS) CPI Advanced Configuration Control Interface CPU Central Processing Unit CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	AL	Automation Line (Board with housing)
CAN Controller Area Network (BUS) CPI Advanced Configuration Control Interface CPU Central Processing Unit CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	BL	Board Line (Board without housing)
CPI Advanced Configuration Control Interface CPU Central Processing Unit CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	BSP	Board Support Package (Software)
Interface CPU Central Processing Unit CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	CAN	Controller Area Network (BUS)
CSI Camera Serial Interface DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	CPI	_
DC Direct Current DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	CPU	Central Processing Unit
DIN Deutsches Institut für Normung, German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	CSI	Camera Serial Interface
German Institute for Standardization (Standards) DIO Digital Input/Output DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DC	Direct Current
DK Development Kit DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DIN	German Institute for Standardization
DL Display Line (Board with Display) DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DIO	Digital Input/Output
DOUT Digital Output DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk /Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DK	Development Kit
DP Display Port DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DL	Display Line (Board with Display)
DSI Display Serial Interface ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DOUT	Digital Output
ECC Error Checking and Correction EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DP	Display Port
EEE Electrical and Electronic Equipment EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	DSI	Display Serial Interface
EHCI Enhanced Host Controller Interface EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	ECC	Error Checking and Correction
EMC Electromagnetic Compatibility eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	EEE	Electrical and Electronic Equipment
eMMC Embedded MulitMediaCard EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	EHCI	Enhanced Host Controller Interface
EN European Norm (Standards) ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	EMC	Electromagnetic Compatibility
ESD Electrostatic Discharge ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	eMMC	Embedded MulitMediaCard
ETH Ethernet (LAN) GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	EN	European Norm (Standards)
GbE Gigabit Ethernet GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	ESD	Electrostatic Discharge
GPIO General-Purpose Input/Output GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	ETH	Ethernet (LAN)
GPU Graphics Processing Unit HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	GbE	Gigabit Ethernet
HD/HDD Hard Disk / Drive HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	GPIO	General-Purpose Input/Output
HDMI High Definition Multimedia Interface HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	GPU	Graphics Processing Unit
HPM PICMG Hardware Platform Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	HD/HDD	Hard Disk /Drive
Management specification family H/W Hardware IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	HDMI	High Definition Multimedia Interface
IEC International Electrotechnical Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	НРМ	
Commission (Standards) IOL IPMI-Over-LAN IOT Internet of Things	H/W	Hardware
IOT Internet of Things	IEC	
	IOL	IPMI-Over-LAN
KVM Keyboard Video Mouse	IOT	Internet of Things
, 333. 4 1.460 1.16436	KVM	Keyboard Video Mouse

LAN	Local Area Network
LED	Light Emitting Device / Diode
LPDDR	Low-Power Double Data Rate (RAM)
LVD	Low Voltage Device
M.2	Next smaller generation of mSATA
MEI	Management Engine Interface
mPCle	Mini PCI-Express
mSATA	Mini SATA
OS	Operating System
PCle	PCI-Express
RAM	Read Access Memory
REV	Revision
RoHS	Restriction of the use of certain
	hazardous substances
ROM	Read-only memory
RPI	Raspberry Pi
RTC	Real Time Clock
SATA	Serial-ATA
SEL	System Event Log
SELV	Safety Extra Low Voltage
SIO	Super Input/output
SMBus	System Management Bus
SMWI	System Monitor Web Interface
SN	Serial Number
SOL	Serial Over LAN
SSD	Solid State Drive
TPM	Trusted Platform Module
UEFI	Unified Extensible Firmware Interface
uHDMI	Micro-HDMI
UL	Underwriters Laboratories (Standards)
USB	Universal Serial Bus
USB OTG	USB On-The-Go (Host)
uSD	MicroSD (Memory Card)
VGA	Video Graphics Array
VLP	Very Low Profile
	•
WEEE	Waste Electrical and Electronic Equipment
WLAN	Wireless LAN
XHCI	eXtensible Host Controller Interface



About Kontron Electronics

Kontron Electronics is your complete supplier of electronics and automation solutions. We offer

- own control products for the automation of machines and devices,
- development and production for individual, complex electronic modules
 - production services for your existing electronic assemblies
- assembly services for complete systems

With our existing control, visualisation and automation systems, we can put together turnkey complete solutions for your machines and equipment in the shortest possible time. For your individual requirements we have a large group of engineers and technicians available, who develop your tailor-made solution with a lot of experience and imagination. Kontron Electronics is a full-service provider for the development and production of complex electronic modules, components and systems for industrial and medical applications.



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